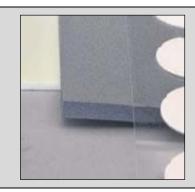
DATASHEET



Softtherm[®]: **86/500 & 86/600**



This group of Softtherm® films has a very good thermal behavior. The films are characterized by low thermal resistance and best heat dissipation, as well as good dielectric strength. Good compressibility and low shore hardness ensure reliable and simple processability.

APPLICATIONS

- RD-RAM Memory Module
- Heat Pipe Thermal Solutions
- Automotive Engine
- Control Units
- Plasma Supply Console

DISCLAIMER: Purchaser shall be solely responsible for determining the adequacy of the product for any and all uses which the purchaser shall apply the product, and the application of the product by the purchaser shall not be subject to any implied warranty of fitness for that purpose.

Available Thicknesses

86/500: 0.5 – 2.0 mm **86/600:** 0.5 – 1.5 mm

Properties	symbol	unit	86/500	86/600
Color			brown	gray
Thermal Properties				
Thermal Resistance	R _{th}	K/W	0.25	0.20
Thermal Impedance	R_{ti}	°Cmm²/W	100	80
		Kin²/W	0.15	0.12
Thermal Conductivity	λ	W/mK	5.0	6.0
Electrical Properties				
Breakdown Voltage	$U_{d;ac}$	kV	1	1.5
Dielectric Breakdown	$E_{d;ac}$	kV/mm	2	3
Volume Resistivity		Ω cm	1.0×10^{11}	1.7 x 10 ¹⁰
Dielectric Loss Factor	$tan \ \delta$	1	1.5 x 10 ⁻³	2.0 x 10 ⁻³
Dielectric Constant	εr	1	3.9	2.5
Mechanical Properties				
Measured Thickness (±10%)		mm	0.5*	0.5*
Hardness		Shore A	70 - 80	60 – 70
Youngs Modulus **		N/cm ²	70	77
Physical Properties				
Density		g/cm³	1.33	1.28
Application Temperature		°C	-60 to +200	-60 to +180
Total Mass Loss (TML)		Ma%	< 0.24	< 0.40
Flame class		UL	-	-
** Youngs Modulus: sample size 30mmx30mmx2.5mm; variable contact pressure;				

** Youngs Modulus: sample size 30mmx30mmx2.5mm; variable contact pressure compression 50% of the measured thickness

Available with Optional Adhesive!

